

EE 552
High Level ASIC Design Using CAD Tools
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Theremin Final Report

Monday, 31 March 2003

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Achievements

Software

VHDL Source Code

All of the necessary components have been designed, written and tested via the use of test benches or ModelSim. The VHDL code has been proven to be functioning properly.

<i>Name of File</i>	<i>Subcomponent and Description</i>	<i>Code Written</i>	<i>Tested</i>	<i>Working Correctly</i>
Inputinterface <i>controls the data AD974 and linearizes output of IR sensors</i>	ADC_module: Interface code for controlling and receiving data from the ADC	●	●	●
	Volumefilter: Linearization of volume signal from IR chip	●	●	●
codec_control <i>control the audio codec</i>	codec_intfc.vhd: Initializes codec	●	●	●
	Channel.vhd: controls timing of codec interface	●	●	●
	Clkgen.vhd: generates clock signals for codec	●	●	●
Wavemaker <i>Sine wave generator depending on frequency and volume</i>	Clk_div.vhd: divides the clock by 256	●	●	●
	Volume_multiplier: Modulates the amplitude of the sine wave	●	●	●
	Sintable.vhd: lutcontroller and mega_sinlut access the LUT on the on-chip RAM to generate sine, square, triangular and sawtooth waveforms.	●	●	●

Table 1 : Software Achievements (VHDL)

These components were also tested from a hardware standpoint. The IR distance measuring sensors, along with the analog to digital converters, were tested by displaying the most significant four bits of the output from the distance measuring sensors to a 7-segment LCD display. The audio codec interface was tested through the use of a loopback program which fed a sine wave through the codec.

Matlab Scripts for the Generation of Waveforms

Through the use of Matlab, binary sine, square, triangle and sawtooth waves were created and stored in the on-chip RAM. The RAM had a length of 256 and a width of 12 bits. The binary data output by the scripts is plotted.

<i>Name</i>	<i>Description</i>	<i>Written</i>	<i>Tested</i>	<i>Working correctly</i>
Binarysawtooth.m	Generates a binary square wave.	●	●	●
Binarysine.m	Generates a binary sine wave.	●	●	●
Binarysquare.m	Generates a binary square wave.	●	●	●
Binarytriangle.m	Generates a binary triangular wave.	●	●	●

Table 2 : Matlab scripts

Overall System Functionality

- **Variation of Pitch of the Instrument**
The user is able to vary the frequency emitted by the Theremin from a minimum of 980.00 Hz to a maximum of 2.94 kHz by moving their hand from a 10 cm to 80 cm distance from the pitch control IR sensor.
- **Variation of Volume of the Instrument**
The user is able to successfully control the volume of the instrument by moving their hand from a 10 cm to 80 cm distance from the IR sensor responsible for pitch control.
- **Selection of Wave Shape**
Through the use of two DIP switches located on the board, the user is able to select from a square, sine, sawtooth and triangular waveform. Each of these waveforms produced a different sound.
- **Sustain Pitch Switch**
A push button enables the user to hold the current frequency which is emitted by the instrument.

Description of Operations

Block Diagram of Data Flow

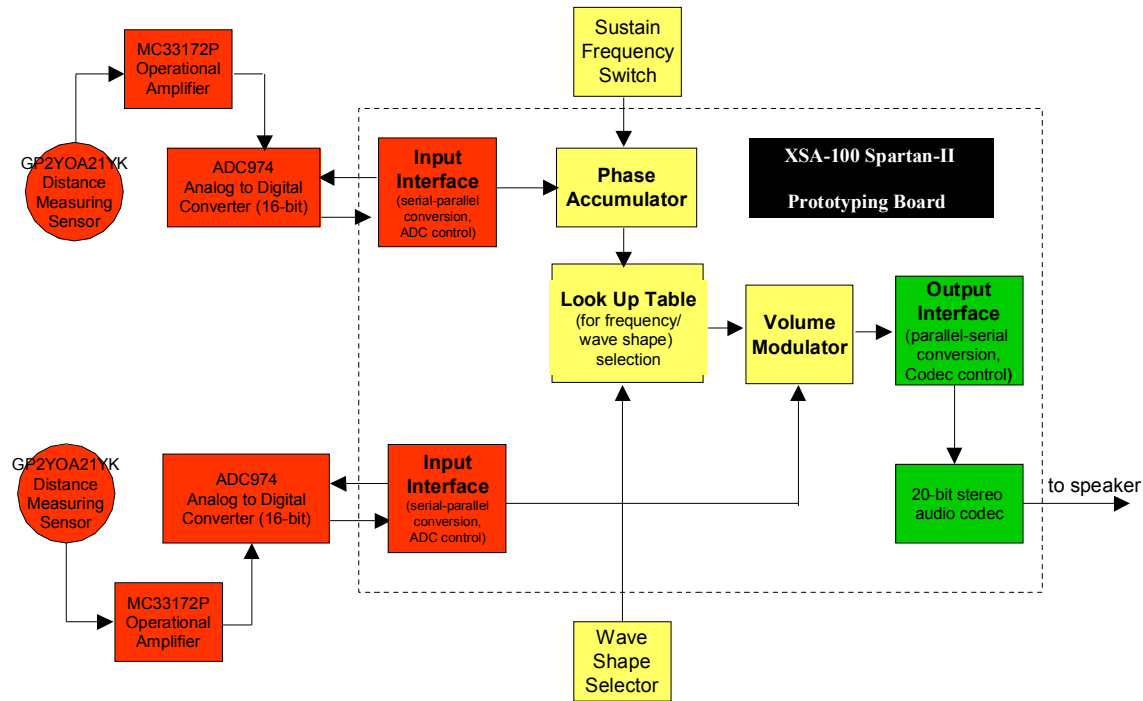


Figure 1 : Block Diagram of Data Flow

System Clock

The frequency of the system clock is 12.5MHz. This is used in order to be able to use the audio codec. The sampling frequency for the codec is 256 times slower than the system clock. With a clock frequency of 12.5MHz, the sampling rate is 48.8kHz which satisfies Nyquist's criteria.

Input Sensor

The theremin will be implemented using IR sensors to measure the distance of the musician's hand from the instrument. The left hand will control the pitch and the right hand will control the volume. The IR sensors, which will be used for this purpose are GP2Y0A21YK from Sharp. (See data sheet attached). The range of analog output voltage of the sensor is 0.4V to 2.4V for detecting distance of 80cm to 10 cm, which is appropriate for the theremin. Also, the sensor is not as influenced by the color of

reflective objects or their reflectivity as other IR sensors since it uses an angle measurement for calculating distance.

Processing of the inputs

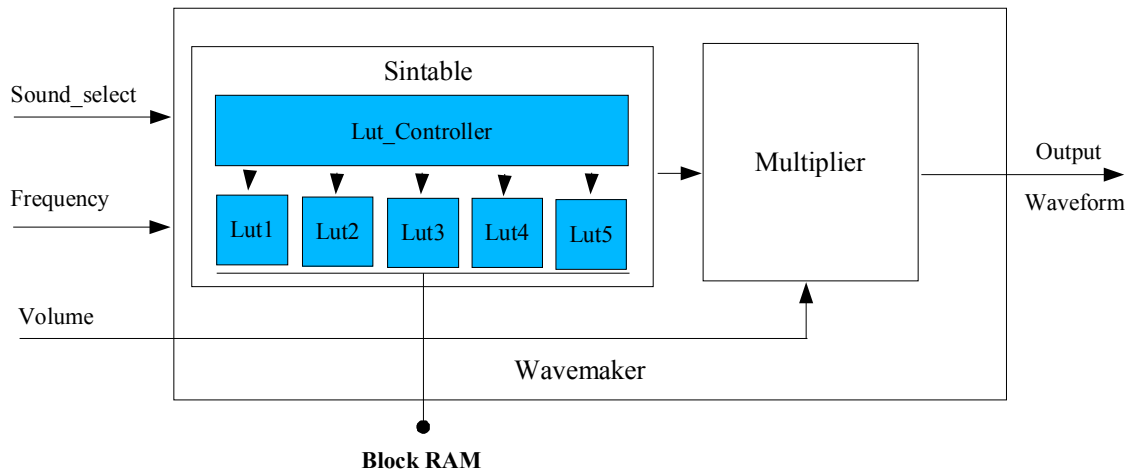
The output of the sensors is an analog voltage. This analog voltage will be converted to digital voltage by a 16-bit Analog to Digital converter (ADC). The range of analog output of the sensors is 0.4V to 2.4V. Since we are operating the ADCs with a 5V supply, the resolution of the ADC is 76 μ V per bit. This gives a potential digital range from 0x148F to 0x7B5B. The ADC puts out serial data.

Pitch and Volume control

The pitch and volume control of the theremin come from the output of the two ADCs. This data will be converted to parallel signals and used by the NCO. The pitch control signal will be used as the input word to the NCO. The volume control signal will be used as a multiplicand in a multiplier for signal amplification.

Wavemaker Module

The wavemaker module is a numerically controlled oscillator (NCO) that generates a output waveform whose frequency and magnitude varies according to the 8 bit frequency and volume inputs. One of 5 waveforms can be selected using the 3 bit sound_select input. The waveforms are stored in Block RAM.



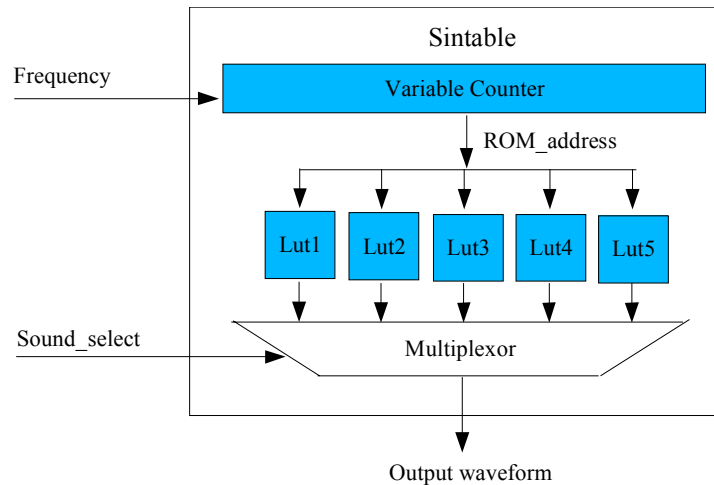
Wavemaker Module Generalized Block Diagram

Figure2: Wavemaker Block Diagram

Sintable Module

The Sintable module generates an output waveform whose frequency varies according to

the 8-bit frequency input. The name 'Sintable' is actually a misnomer since it can output *any* waveform that is stored in one of five Block Ram modules, not only a sinusoidal waveform. The desired waveform is selected with the sound_select input.



Sintable Module Generalized Block Diagram

Figure 3 : Sintable Block Diagram

The sintable module consists of a variable counter and 5 ROM look up tables (LUT's). The 12-bit counter corresponds to the phase of the waveform, and the 8-bit frequency input is added to the counter every 256 clock cycles. (Each output value is held for 256 clock cycles while it is transferred serially to the Audio Codec). The 8 MSBs of the counter are used to address the selected ROM LUT. Each ROM LUT stores 512 12-bit samples that make up a single wavelength of a periodic sound sample. Increasing the frequency input increases the frequency at which the LUT is traversed, thereby increasing the frequency of the output wave.

Calculation of Output Frequency

The period T of the output wavelength can be calculated in the following way:

$$T = 256 \times \text{Clock Period} * (\text{Samples/Wavelength}) / (\text{Frequency Input} / 8)$$

For example, if

Clock Period = 80ns(12.5MHz)

Samples/Wavelength = 512

Frequency Input = 1

The output wavelength frequency $f = 1/T = 11.92$ Hz. This also corresponds to the frequency resolution.

For a frequency input = 255 (the maximum for an 8 bit input)
 $f = 1/T = 3040$ Hz. This corresponds to the maximum output frequency of the sintable module.

Output processing

The output of the volume modulator will be sent to a parallel to serial converter, which will be coded and downloaded to the FPGA. Its output will be sent to the stereo audio codec on the Xstend board. The stereo codec accepts serial bit stream from the XS board which converts it into two analog output signals. These signals will be fed into an amplifier and output through a speaker

Diagram of Design Hierarchy

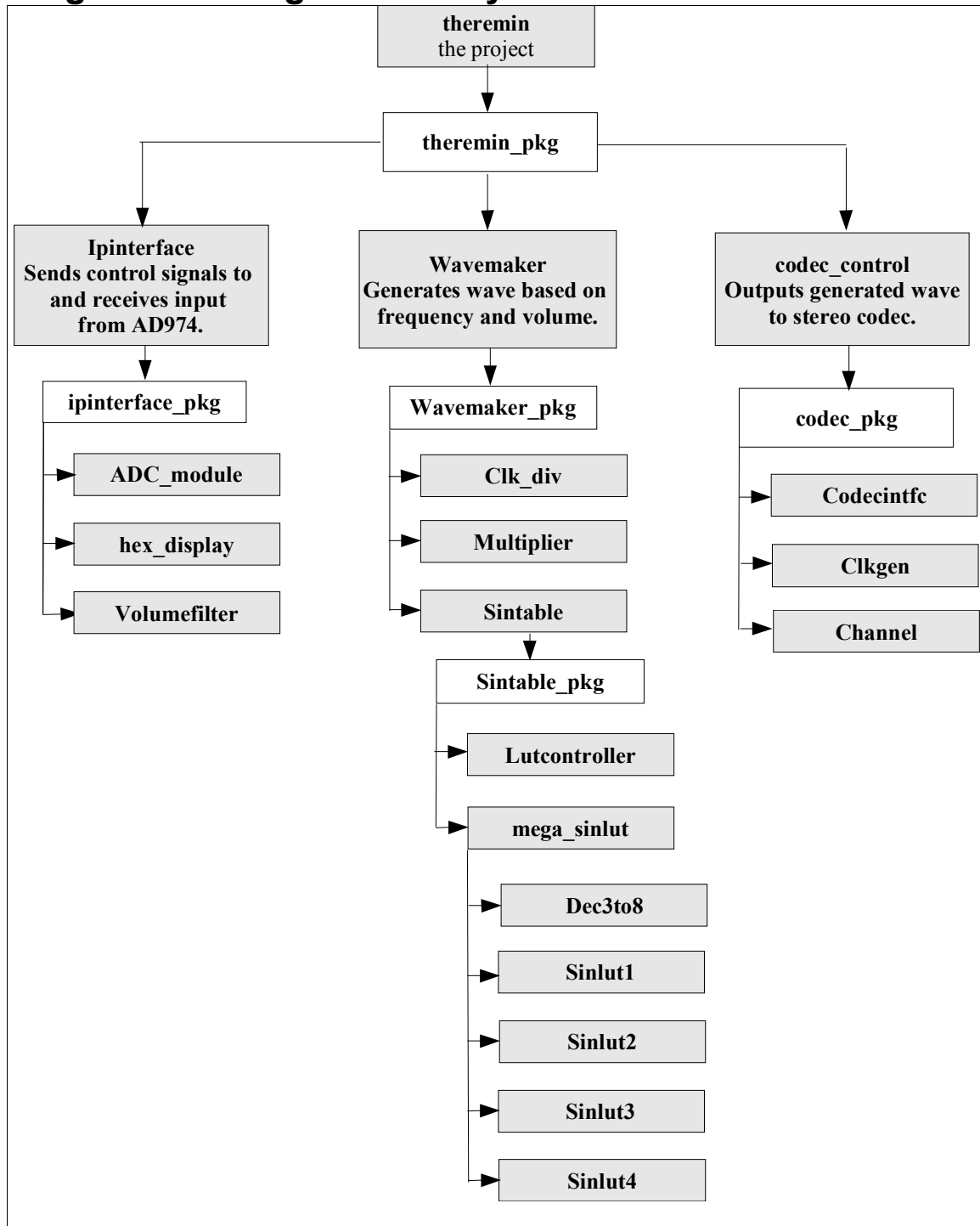


Figure 4 : Design Hierarchy Diagram

Theremin Data Sheet

High Tech Musical Instrument

Block Diagram

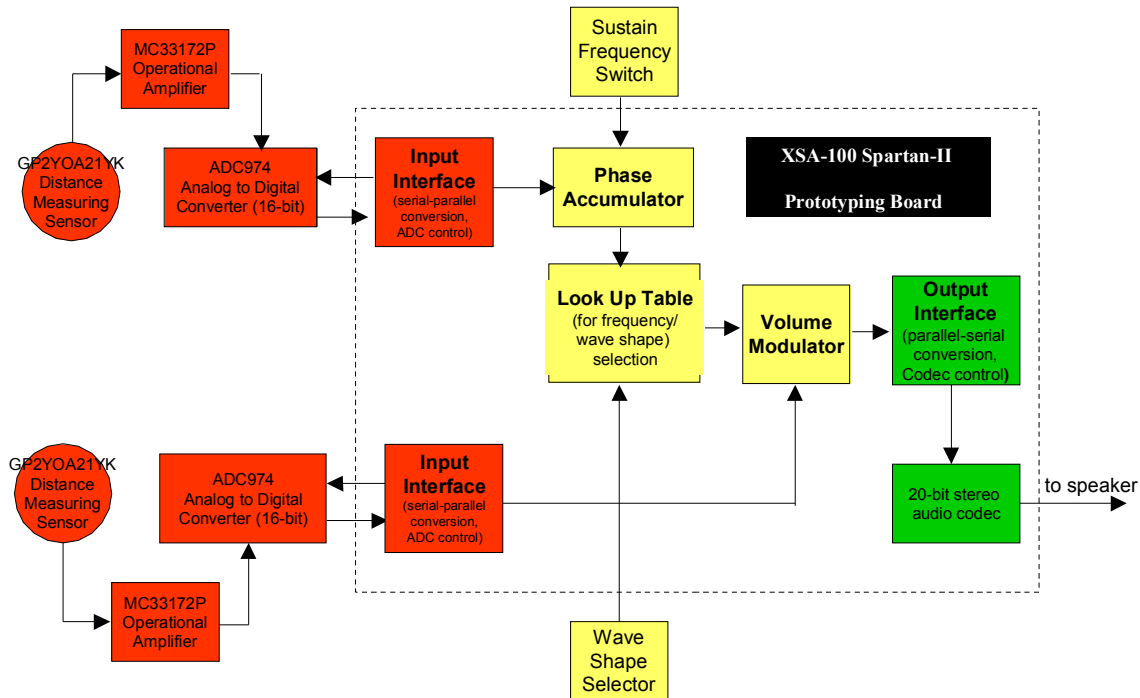


Figure 5 : Block Diagram of Data Flow

Features

- Both volume and frequency control
- Produces sine, sawtooth, triangular, square, and synth audio signals
- Output frequencies vary from 980Hz to 2.9 KHz
- Frequencies are produced using the Direct Digital Synthesizer (DDS) method
- Utilizes an IR Distance Measuring Sensor from Sharp
- Employs a Fast 16-Bit ADC with 200 kSPS Throughput From Analog Devices
- ADC operates at a 48kHz sampling rate
- Controlled from a Xilinx Spartan II FPGA running on a Xess XSA Board
- Utilizes $256K \times 16$ of RAM and 5 blocks of $256K \times 16$ ROM

General Description

The Theremin is a musical instrument which can be played without physical contact. The Theremin utilizes two Sharp IR sensors to measure the distance of a players hand to vary the pitch and volume of the output. The Theremin can produce several different output

waveforms including sine, sawtooth, and square waves. The controller of the Theremin is implemented on a Spartan II FPGA which is embedded on a XESS XSA board. An Analog Devices AD974 analog to digital converter is used to convert the signal from the IR sensors to 16 bit digital data at a 48kHz sampling frequency. The digital output from the FPGA is converted to analog by way of a 20 bit DAC provided on the XSA board. The Theremin operates off a single +9V power supply. The Theremin produces output frequencies via the Direct Digital Synthesizer (DDS) method. Waveforms are stored in lookup tables from which the frequency can be varied by skipping samples in the table. As more samples in the LUT are skipped the frequency of the output signal will increase. The Theremin is fabricated using EE552's patented "no sleep" process.

Parameter	Condition	Min	Typ	Max	Units
IR Sensor Characteristics					
Detecting Distance		10		80	cm
Distance Measurement Sampling Rate			26		Hz
Output Voltage (no load)		0		3.5	volts
ADC Characteristics					
Resolution			16		bits
Bit Rate			12.5		Mbits/sec
Sampling Rate			48		kHz
Input Voltage		0		4	volts
FPGA Characteristics					
# of logic blocks			327		volts
ROM			5		Blocks of 256k by 16
Maximum speed			9.1		ns
Overall Characteristics					
Output frequency range		0.98		2.9	kHz

Table 3 : Characteristics

I/O Pin Descriptions

Common pins to all interfaces

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description</i>
88	Clock: in	Stepped down clock at 12.5 MHz
26	Reset : in	Reset pushbutton on the XSA board

Table 4: Common pins to all interfaces

ADC Interface for pitch detection

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description of ADC pins connected to FPGA</i>
20	DATACLK_pitch: out	Serial data clock for both ADCs
21	ADC_data_pitch : in	Data output from the ADC
23	Busy_pitch : in	Busy signal. Goes low when a conversion is started, and remains low until the conversion is completed and the data is latched into the on-chip shift register.
49	Sync_pitch: in	Digital output frame synchronization for use with an external data clock. When a read sequence is initiated, a pulse one DATACLK period wide is output synchronous to the external data clock.
57	CS_pitch : out	Chip Select Input. With R/C low , a falling edge on CS will initiate a conversion. With R/C high, a falling edge on CS will enable the serial data output sequence.
22	RC_pitch: out	Read/Convert Input. Used to control the conversion and read modes. With CS LOW, a falling edge on R/C holds the analog input signal internally and starts a conversion; a rising edge enablesthe transmission of the conversion result.
64,65,66,50, 51,54,56	LED_disp: out	LED display for demonstration purposes

Table 5: ADC Interface for pitch detection

ADC Interface for volume detection

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description of ADC pins connected to FPGA</i>
94	ADC_data_vol : in	Data output from the ADC
19	Busy_vol : in	Busy signal. Goes low when a conversion is started, and remains low until the conversion is completed and the data is latched into the on-chip shift register.
86		Digital output frame synchronization for use with

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description of ADC pins connected to FPGA</i>
	Sync_vol: in	an external data clock. When a read sequence is initiated, a pulse one DATACLK period wide is output synchronous to the external data clock.
13	CS_vol : out	Chip Select Input. With R/C low , a falling edge on CS will initiate a conversion. With R/C high, a falling edge on CS will enable the serial data output sequence.
12	RC_pitch: out	Read/Convert Input. Used to control the conversion and read modes. With CS LOW, a fallingedge on R/C holds the analog input signal internally and starts a conversion; a rising edge enablesthe transmission of the conversion result.

Table 6: ADC Interface for volume detection

Output interface to Stereo Codec

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description</i>
77	Mclk:out	This output is the master clock for the codec chip.
75	Sclk:out	This output is the clock for synchronizing serial data transfers between the FPLD and the codec.
59	Lrclk:out	This output controls the activation of the left and right channel circuitry in the codec.
76	Sdin:out	The serial data stream for the codec DAC is shifted out through this output.

Table 7 :Output interface to Stereo Codec

Other Pins

<i>FPGA pins</i>	<i>Signal name</i>	<i>Description</i>
111	foot_pedal	This input will hold the volume and pitch at their current values.
68,44	switch	This switch will be used to select between 4 different kinds of waves

Table 8 :Other pins used in the project

Wave Selection

<i>Switch</i>	<i>Description</i>
'000'	Sine wave
'001'	Sawtooth wave
'011'	Square wave
'100'	Triangle wave

Table 9 : Swich Descriptions

Timing Specifications

External Components

<i>Component</i>	<i>Description</i>	<i>Maximum Sampling Frequency</i>
GP2Y0A21YK	Distance measuring sensor.	26.1 Hz
AD974	16-bit serial analog to digital converter.	200 kHz
Xstend Codec	20-bit stereo audio codec.	46.875 kHz

Table 10 : External Components

Internal Components

<i>Component Name</i>	<i>Maximum Clock Frequency</i>
Codec control	108.59 MHz
IP interface	110.14 MHz
Wavemaker	73.41 MHz
Theremin	65.41 MHz

Table 11 : Internal Components

The Sharp GP2Y0A21YK General Purpose Distance Measuring Sensors have the lowest frequency of all the components and is thus the limiting factor in the determination of the maximum frequency of the Theremin.

Chip Performance and Resources

Component	Logic Slices Required (1200 Total Available)	Minimum Clock Period (Post Place & Route) (ns)	Maximum Clock Frequency (Post Place & Route) (Mhz)
Theremin	327	15.289ns	65.407MHz
Codec Control	47	9.209ns	108.589MHz
IPInterface	79	9.079ns	110.144MHz
ADC_Module	32		
Hex_Display	4		
Wavemaker	250	13.623ns	73.405MHz
Clk_Div	40		
Multiplier	50		
Sintable	137		
LUT_Controller	52		
Mega_sinlut	40		
Dec3to8	4		
Sinlut1-5(Block RAM)	5 x 512K * 16bits = 4096Kbits		

Resource Requirements: Memory Utilization and Timing Analysis

Table 12 : Resource Requirements

Results of Experiments and Characterization

Input Interface

It was necessary to characterize the output of the IR sensor for consideration in the design of the firmware part of the project. The following figure shows the output voltage of the IR sensor versus the distance of a hand from the sensor.

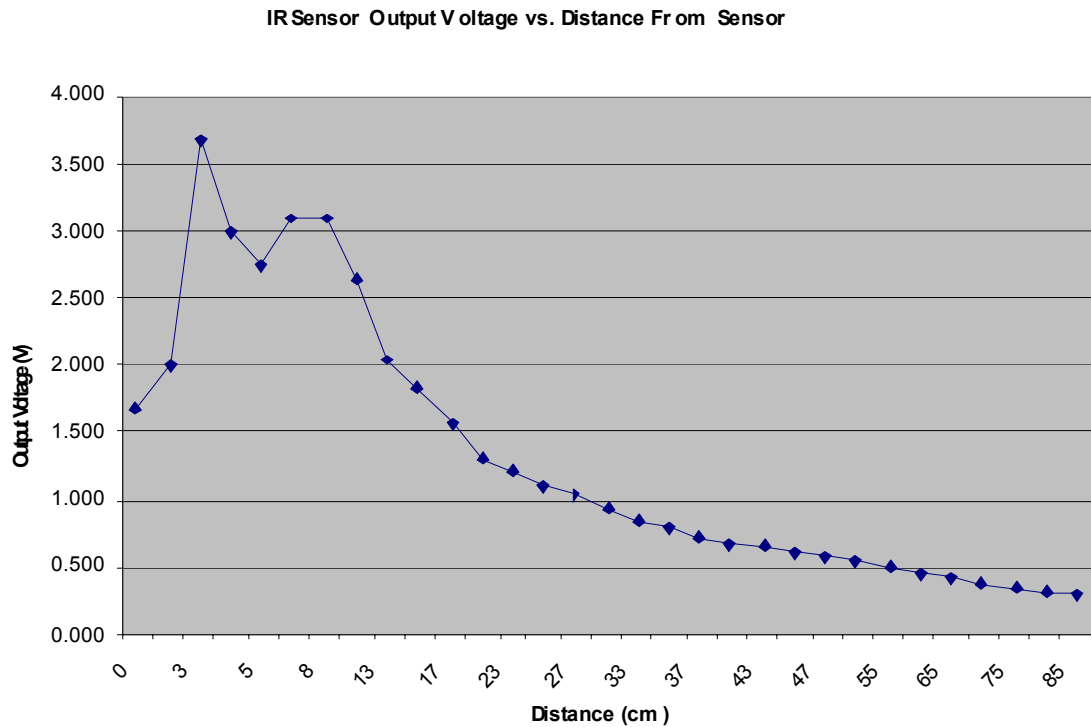
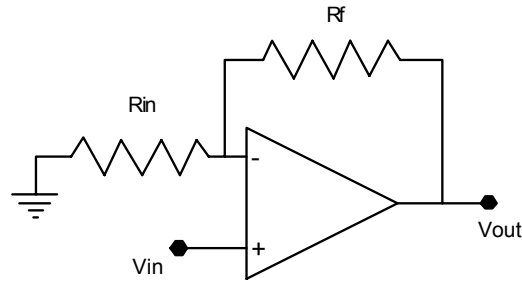


Figure 6: IR Sensor Voltage vs Distance

The sensor output is not linear and it resembles a decaying exponential. This will make accurately reading the output at the higher distances difficult because the resolution is so low. An ADC of 16-bits was chosen to try to be able to measure this low resolution. The sensor was connected to the ADC and a test program was written to make sure the data was being received. The top four bits of the ADC were put onto a seven segment LED display as hex values. These values were seen to vary as the voltage of the sensor was varied.

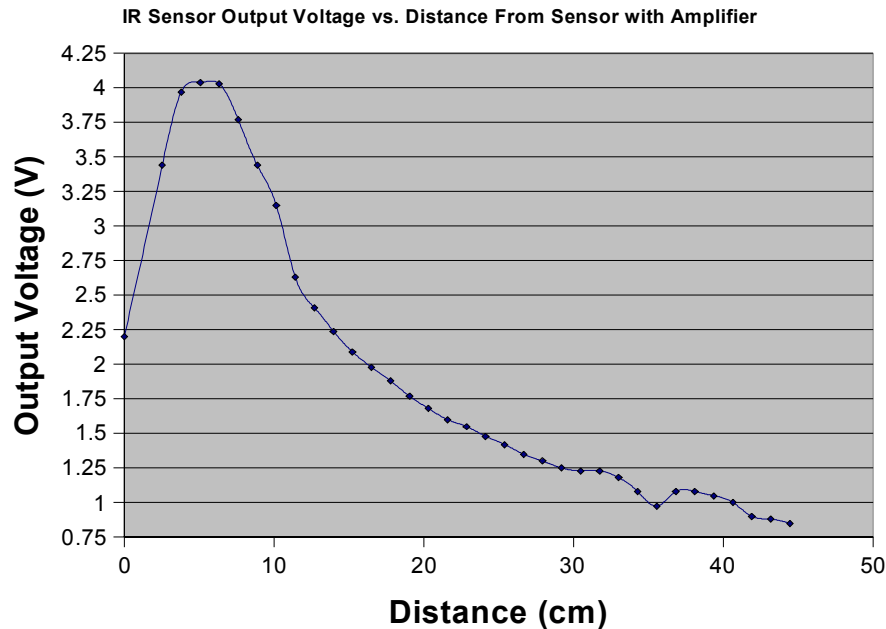
When the sensor was connected to the ADC, loading was observed on the



sensor output signal so that the maximum voltage was only 2.8 volts. In order to alleviate this problem and to increase the input voltage range, a MC3317 op amp was used as a buffer between the sensor and the ADC. The maximum voltage needed to be scaled from 2.8 volts to 4.0 volts. The minimum voltage could have been scaled so that the minimum output of the sensor was zero, but this would have required a negative voltage supply and so was not implemented.

Figure 7: Inverting Op Amp

The non-inverting configuration was used with the input of the sensor going into the '+'



input of the op amp. The gain of the non-inverting configuration is $1 + R_f/R_{in}$. To scale 2.8 to 4.0 volts, a gain of 1.4 was calculated. After experimentation, it was determined that a gain of 1.04 was all that was needed to scale the output to have a maximum at 4.0

volts at the input to the ADC. The resistor values chosen were 104Ω and 4Ω . The resulting voltage vs. distance graph can be seen in Figure 2. The op amp did not increase the resolution as hoped but it did provide buffering into the ADC.

Figure 8: IR Sensor Voltage vs. Distance from Sensor with Amplifier

The output voltage of the IR sensor was found to fluctuate by as much as half a volt. It was thought that this was being caused by noise on the power supply line caused by the ADC. Upon scoping the 5V supply shared by the IR sensor and the ADC we noticed a dip in the voltage up to 0.88V in amplitude, repeating at a frequency of 980Hz. This is suspiciously similar to the minimum output frequency but no correlation was able to be determined between these two facts. When the ADC was disconnected and the power supply was connected directly to the IR sensor, its output voltage no longer fluctuated. To remedy the power supply voltage noise, a $2.2\mu\text{F}$ capacitor was added to the $10\mu\text{F}$ and $0.1\mu\text{F}$ capacitors already being used to filter the supply voltage. However, the extra capacitor did not make a difference.

While testing the ADC it was noticed that even when the power supply was shut off, there was 2 volts on the power line of the breadboard that the ADC and IR sensor are on. Upon further testing it became obvious that this power was being supplied by the control signals of the FPGA and was propagating through V_{DIG} (digital voltage supply) of the ADC onto the power line. This characteristic of the ADC did not seem to be causing any problems and had no immediate solution other than changing ADC chips, and so it was left as is.

All control and data signals for the ADC are carried to and from the FPGA by way of a ribbon cable. However, this ribbon cable has a large amount of capacitance which had some negative effects. Namely, it caused problems on the data line where logic high signals were just barely able to get above the logic high threshold during the sampling period.

Output Interface

Since sound must be produced at the final output, a converter from a digitally encoded wave to an analog sound wave must be used. Fortunately, there is one built into the development board that is being used for this project. The audio codec chip that is being used is the AKM AL4520A 20-bit stereo ADC & DAC. The XESS company that makes the development board has a sample program called loopback on their website that takes in audio data from the ADC and puts it back onto the DAC unaltered. This program was used as the initial test for the audio codec.

The loopback program compiled nicely but the pin assignments were a problem. The assignments given in the documentation were wrong for the board that is being used for this project. So the correct assignments had to be found and put in the user constraints file. After this was done, the program worked as expected. When a

portable CD player was attached to the input jack and a mini-speaker was attached to the output, the cool tunes of Depeche Mode were enjoyed by all.

The sounds that the theremin produces are generated internally and so the loopback program had to be modified in order to be able to be used for this project. A simple program that created a repetitive waveform internally was used to test the feasibility of an internally generated wave.

Wavemaker Module

The wavemaker module consists of a clock divider (clk_div.vhd), Numerically Controlled Oscillator (sintable.vhd) and a multiplier.

Clock Divider: Using 'False' Clocks

The clock divider module is used so that each output value of the wavemaker module is held for 256 clock cycles as it is transferred serially to the Audio Codec. Originally, the clock divider module was actually a clock divider, and the clock input of all wavemaker modules was a slower version of the system clock. However, it was found that using a 'false' clock could result in glitches and clock skew problems when the wavemaker modules were interfaced with external modules. So, the clock divider's 'slow_clk' output was instead routed to the enable inputs of the various wavemaker modules. The behaviour of the wavemaker module became more stable and predictable.

Using RAM: Distributed vs. Block RAM

RAM is used to store the sound samples for the Numerically Controlled Oscillator. Two types of on-chip RAM were investigated and implemented, and the implementation results compared; Distributed RAM and Block RAM. Both types of RAM were designed using the Xilinx Core Generator tool.

Distributed RAM.

Distributed RAM is implemented using on-chip configurable logic blocks (CLB). The disadvantage of using logical blocks as memory elements is that it uses logical resources that may be required for other logical or arithmetic modules.

Block RAM.

Each Spartan II FPGA contains 10 256K x 16 bit dedicated ROM Blocks, for a total of 4096 Kbytes of on-chip memory. This amount of memory was sufficient for our purposes. Using ROM Blocks conserves CLB's for other modules that may need them.

5 Blocks of 256 * 12 bits of memory (1.92 Kbytes) was allocated using Distributed and Block Memory. The results are shown below.

Resource Requirements of Distributed and Block RAM for a SPARTAN II FPGA

<i>Component</i>	<i>Logical Slices Used /ROM Blocks Used</i>	
	<i>Distributed RAM</i>	<i>Block RAM</i>
Theremin	899/0	327/5
Wavemaker	731/0	250/5

As can be seen in the table above, 481 fewer logical slices were used in the version of the Sintable module that used BLOCK RAM. So, 1 Kbyte of RAM(ROM) corresponds to $480/1.92\text{Kbytes} = 250$ Logical Slices. The savings in logical elements is significant, considering that there are only 1200 logical slices available on the SPARTAN II FPGA.

Integrated Project

Preliminary experimentation was done by hardcoding simulated frequency and volume values into the full design. When this was done, the wave look up tables performed as expected and the different waveforms were heard at the output.

Once the preliminary testing was performed the input interface was connected. Initial testing was conducted empirically by listening to the output. The theremin was found to work somewhat as expected with a frequency that varied with the movement of the player's hand. However, there were noticeable unwanted frequencies present in the output tone. It was observed that at one frequency all the noise disappeared and a pure tone was heard. From this knowledge, it was determined that the unwanted noise was caused by the input from the sensors switching too rapidly. Many attempts were made to try to rectify this problem:

- A lowpass filter was used between the output of the sensor and the input of the ADC. This helped the problem but decreased the resolution substantially.
- All bits except for the most significant 2 were truncated. By doing this, four different discreet levels were heard. But in the transition region, the signals were still very noisy. On the oscilloscope, it could be seen that the wave changed frequency faster than it could complete a full wavecycle. With the wave switching between frequencies like this, higher frequency components got put in the signal. Thus, it was assumed that this was the problem with the signal with more significant bits as well.
- A delay was put into the ADC controller to delay how often it sent data to the FPGA. This seemed to help a bit but it still was switching quite rapidly in the transition regions.
- An averaging component was used to smooth out the data from the ADC. This provided the biggest improvement in signal quality. The values for delay and number of averages taken were then tweaked to provide the best quality sound.

The range of frequencies that could be produced also had to be adjusted to get the greatest range with the smallest frequency increment. This was done by changing the phase accumulator width and the width of the frequency control word.

Externally Provided HDL Elements

The externally provided HDL component used in this project comes from XESS corporation. They have provided a module called `codec_intf` for controlling the audio codec on the Xtend board. They use this module in a program called `loopback.vhd` which takes a stereo audio signal from the input jack and plays it back to the output jack. Since the theremin does not need to use the ADC on the codec, the portion for reading in data from the ADC can be taken out.

References

1. AD974: 4-Channel, 16-bit 200 kSPS Data Acquisition System. Copyright 1999 by Analog devices. <http://www.analog.com>.
2. Arbitrary Waveform Generators & Function Generators. Copyright 2001 by K. Yokogawa. http://www.yokogawa.com/tm/GC/fg/fg_overview.pdf.
3. "Direct Digital Synthesizer with an On-Chip D/A-Converter," IEE Journal of Solid-State Circuits, Vol. 33, no. 2. Copyright February 1998 by Jouka Vankka. http://clsi2.kaist.ac.kr/project/ddfs_paper/33ssc02-vankka.pdf.
4. EE 552 Application Notes: 2-D Mapper. Copyright 1998 by Shaun Luon, Clifton Yeung, J.P. Kinsky and Patrick Asiedu-Ampem. <http://www.ee.ualberta.ca/~elliott/ee552/projects/1998f/2-DMapper/transmit.vhd>
5. "GP@Y0A21YK: General Purpose Type Distance Measuring Sensors." Copyright 2003 by Sharp Semiconductors. <http://www.sharpsma.com>.
6. XSA Board v. 1.1, 1.2 User Manual: How to Install, Test and Use Your New XSA Board. Copyright May 2002 by XESS Corporation. http://www.xess.com/manuals/xsa-manual-v1_2.pdf
7. Xstend Board V1.2.2 Manual: How to Install and Use Your New Xstend Board. Copyright May 2001 by Xess Corporation. http://www.xess.com/manuals/xst-manual-v_1_3_2.pdf.